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STMicroelectronics STPS30H60CGY-TR

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STPS30H60-Y

Automotive power Schottky rectifier

Datasheet – production data

Features

- High junction temperature capability
- Avalanche rated
- Low leakage current
- Good trade-off between leakage current and forward voltage drop
- High frequency operation
- AEC-Q 101 qualified

Description

Dual centre tab Schottky rectifier suited for high frequency switch mode power supply.

Packaged in D²PAK, this device is designed for use in automotive applications. In these applications this device provides a good margin between the remaining voltage applied on the diode and the voltage capability of the diode.

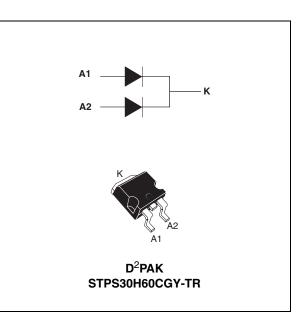


Table 1. Device summary

| Symbol | Value |
|----------------------|----------|
| I _{F(AV)} | 2 X 15 A |
| V _{RRM} | 60 V |
| Tj | 175 °C |
| V _{F (typ)} | 0.535 V |



Characteristics

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Table 2. Absolute ratings (limiting values per diode)

| Symbol | Parameter | | | | Unit | |
|---------------------|--|-----------------------------|-----------------------------------|--------------|------|--|
| V _{RRM} | Repetitive peak reverse voltage | | | 60 | V | |
| I _{F(RMS)} | Forward rms current | | | 30 | А | |
| 1 | Average forward current, $\delta = 0.5$ | T _ 155 °C | Per diode | 15 | Α | |
| IF(AV) | | T _c = 155 °C | Total package | 30 | А | |
| I _{FSM} | Surge non repetitive forward current | t _p = 10 ms sinu | t _p = 10 ms sinusoidal | | А | |
| P _{ARM} | Relative peak avalanche power $T_j = 125 \ ^{\circ}C$ $t_p = 10 \ \mu s$ | | 715 | W | | |
| Тj | Operating junction temperature range ⁽¹⁾ | | -40 to + 175 | °C | | |
| T _{stg} | Storage temperature range - | | | -65 to + 175 | °C | |

1. $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3.Thermal parameters

| Symbol | Parameter | Value | Unit |
|----------------------|----------------------------|-------|------|
| Б | Junction to case Per diode | 1.5 | |
| R _{th(j-c)} | Total | 0.8 | °C/W |
| R _{th(c)} | Coupling | 0.1 | |

Table 4. Static electrical characteristics

| Symbol | Parameter | Test conditions | | Min. | Тур. | Max. | Unit |
|-------------------------------|-------------------------|-------------------------|-----------------------|------|------|------|------|
| I _B ⁽¹⁾ | Povorso lookago ourront | T _j = 25 °C | V _V | | | 60 | μA |
| 'R`´ | Reverse leakage current | T _j = 125 °C | $V_{R} = V_{RRM}$ | | 8 | 25 | mA |
| | | T _j = 25 °C | 7 | | | 550 | |
| | | T _j = 125 °C | | | 435 | 470 | |
| V _F ⁽²⁾ | Forward voltage drop | T _j = 25 °C | l _F = 15 A | | | 660 | mV |
| VF. | | T _j = 125 °C | | | 535 | 570 | - |
| | | T _j = 25 °C | I _F = 30 A | | | 820 | |
| | | T _j = 125 °C | | | 635 | 690 | |

1. Pulse test: $t_p = 5 \text{ ms}, \delta < 2\%$

2. Pulse test: $t_p = 380 \ \mu s, \delta < 2\%$

To evaluate the conduction losses use the following equation:

 $P = 0.45 \text{ x } I_{F(AV)} + 0.008 \text{ x } I_{F}^{2}_{(RMS)}$







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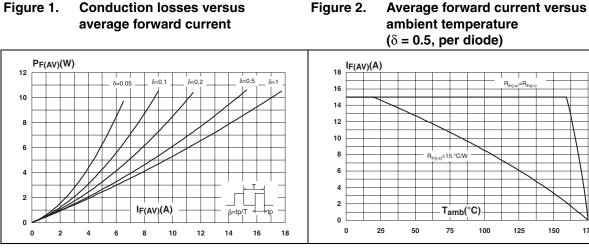
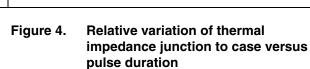
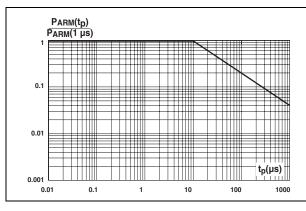


Figure 3. Normalized avalanche power derating versus pulse duration





Reverse leakage current versus Figure 5. reverse voltage applied (typical values, per diode)

T_i=75°C

25 30

T=25°C

I_R(mA)

1.E+02

1.E+01

1.E+00

1.E-01

1.E-02

1.E-03

0 5 10 15 20

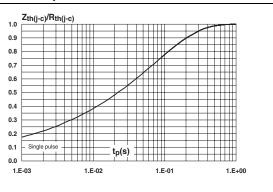
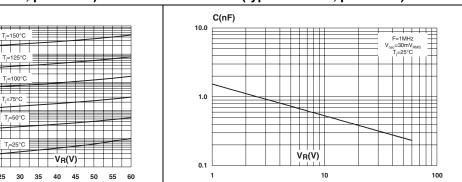


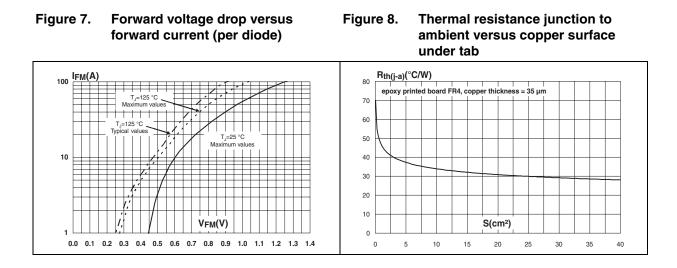
Figure 6. Junction capacitance versus reverse voltage applied (typical values, per diode)

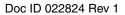




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Package information

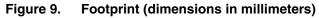
2 Package information

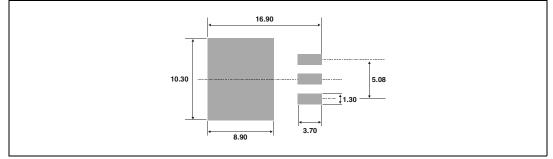
- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

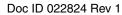
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Dimensions Ref. Millimeters Inches Min. Max Min. Max. 4.40 4.60 0.173 0.181 А 2.49 0.098 A1 2.69 0.106 L2 0.03 0.001 A2 0.23 0.009 В 0.70 0.93 0.027 0.037 B2 1.14 1.70 0.045 0.067 L С 0.45 0.60 0.017 0.024 C2 1.23 1.36 0.048 0.054 D 8.95 9.35 0.352 0.368 10.00 0.393 0.409 Е 10.40 G 4.88 5.28 0.192 0.208 L 15.00 15.85 0.590 0.624 L2 1.27 1.40 0.050 0.055 L3 1.40 1.75 0.069 0.055 * FLAT ZONE NO LESS THAN 2m 2.40 3.20 0.094 Μ 0.126 R 0.40 typ. 0.016 typ. V2 0° 8° 0° 8°

Table 5.D²PAK dimensions









Ordering information

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3 Ordering information

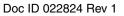
Table 6. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|-----------------|-----------------|--------------------|--------|----------|---------------|
| STPS30H60CGY-TR | STPS30H60CGY-TR | D ² PAK | 1.48 g | 1000 | Tape and reel |

4 Revision history

Table 7.Document revision history

| Date | Revision | Changes |
|-------------|----------|--------------|
| 20-Mar-2012 | 1 | First issue. |







STPS30H60-Y

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